

Special Issue

Modeling, Simulation and Control of Flexible Manufacturing Systems

Message from the Guest Editor

This Special Issue of *Processes* will cover recent advances in the modeling, optimization, monitoring, and control of different sub-processes in flexible manufacturing with a particular interest in machining.

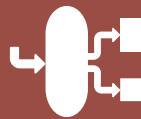
Guest Editor

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Deadline for manuscript submissions

closed (20 August 2023)



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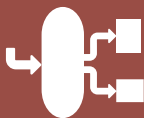


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